

**PATENT ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT								
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT								
<b>CONVEYING PARTY DATA</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Won-Kyu KWAK</td> <td>08/25/2005</td> </tr> <tr> <td>Kwan-Hee LEE</td> <td>08/25/2005</td> </tr> <tr> <td>Seung-Yong SONG</td> <td>08/25/2005</td> </tr> </tbody> </table>		Name	Execution Date	Won-Kyu KWAK	08/25/2005	Kwan-Hee LEE	08/25/2005	Seung-Yong SONG	08/25/2005
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Won-Kyu KWAK	08/25/2005								
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Seung-Yong SONG	08/25/2005								
<b>RECEIVING PARTY DATA</b>									
<b>Name:</b>	Samsung SDI Co., Ltd.								
<b>Street Address:</b>	575 Shin-dong, Yeongtong-gu, Gyeonggi-do								
<b>City:</b>	Suwon-si								
<b>State/Country:</b>	KOREA, REPUBLIC OF								
<b>PROPERTY NUMBERS Total: 1</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11138323</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11138323				
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Application Number:	11138323								
<b>CORRESPONDENCE DATA</b>									
<b>Fax Number:</b>	(703)288-5139								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
<b>Phone:</b>	703-288-5105								
<b>Email:</b>	patent@park-law.com								
<b>Correspondent Name:</b>	H.C. Park & Associates, PLC								
<b>Address Line 1:</b>	8500 Leesburg Pike								
<b>Address Line 2:</b>	Suite 7500								
<b>Address Line 4:</b>	Vienna, VIRGINIA 22182								
<b>ATTORNEY DOCKET NUMBER:</b>	61610533US								
<b>NAME OF SUBMITTER:</b>	Hae-Chan Park								
<b>Total Attachments: 2</b> source=61610533US Assignment Document#page1.tif source=61610533US Assignment Document#page2.tif									

OP \$40.00 11138323

Docket No.: 6161.0533.US

**ASSIGNMENT**

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in

an application for United States Letters Patent entitled

**ELECTROLUMINESCENCE DISPLAY DEVICE AND METHOD OF MANUFACTURING THE SAME**

("Application");

upon which United States Letters Patent, Patent Number \_\_\_\_\_, has issued ("Patent");

Whereas, Assignor desires to convey all rights, title and interests in and to the same to Samsung SDI Co., Ltd. ("Assignee"), with offices located at 575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, The Republic of KOREA ;

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States, , any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or inventor's certificates and related rights heretofore or hereafter filed for the invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the U.S. or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense..

IN WITNESS WHEREOF, Assignor has hereunto set hand and seal.

Assignor:

Signature: 

Print Name: Won-Kyu Kwak

Address: c/o Samsung SDI Co., Ltd., 575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do,

Docket No.: 6161,0533.US

Republic of Korea

Date: 25 August 2005

Assignor:

Signature: Kwan-Hee Lee

Print

Name: Kwan-Hee Lee

Address: c/o Samsung SDI Co., Ltd., 575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do,  
Republic of Korea

Date: 25 August 2005

Assignor:

Signature: Seung-Yong Song

Print

Name: Seung-Yong Song

Address: c/o Samsung SDI Co., Ltd., 575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do,  
Republic of Korea

Date: 25 August 2005